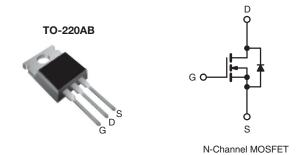


Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	900			
$R_{DS(on)}(\Omega)$	V _{GS} = 10 V	3.7		
Q _g (Max.) (nC)	78			
Q _{gs} (nC)	10			
Q _{gd} (nC)	42			
Configuration	Single			



FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



DESCRIPTION

Third generation MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universially preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRFBF30PbF
Lead (FD)-life	SiHFBF30-E3
SnPb	IRFBF30
	SiHFBF30

PARAMETER			SYMBOL	LIMITE	UNIT	
Drain-Source Voltage			V _{DS}	900		
Gate-Source Voltage			V _{GS}	± 20	V	
Continuous Drain Current	V -140V	T _C = 25 °C		3.6		
	V _{GS} at 10 V	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		2.3	A	
Pulsed Drain Current ^a			I _{DM}	14		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	250	mJ	
Repetitive Avalanche Current ^a			I _{AR}	3.6	А	
Repetitive Avalanche Energy ^a			E _{AR}	13	mJ	
Maximum Power Dissipation	T _C =	25 °C	P _D	125	W	
Peak Diode Recovery dV/dt ^c			dV/dt	1.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 10 s		Ü	300 ^d	7	
Mounting Torque	6 20 0 1	C 00 av M0 assess		10	lbf ⋅ in	
	6-32 or M3 screw			1.1	N⋅m	

Notos

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 36 mH, R_g = 25 Ω , I_{AS} = 3.6 A (see fig. 12).
- c. $I_{SD} \le 3.6$ A, $dI/dt \le 70$ A/ μ s, $V_{DD} \le 600$, $T_{J} \le 150$ °C.
- d. 1.6 mm from case.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62		
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	1.0		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	900	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		1.1	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	4.0	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 20 V		-	± 100	nA
Zava Cata Valtaga Drain Current		V _{DS} = 900 V, V _{GS} = 0 V		-	-	100	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 720 V	V _{DS} = 720 V, V _{GS} = 0 V, T _J = 125 °C		-	500	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.2 A ^b	-	-	3.7	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	100 V, I _D = 2.2 A ^b	2.3	-	-	S
Dynamic							
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	1200	-	pF
Output Capacitance	C _{oss}]	$V_{DS} = 25 \text{ V},$		320	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	200	-	
Total Gate Charge	Qg			-	-	78	
Gate-Source Charge	Q_{gs}	V _{GS} = 10 V	V_{GS} = 10 V I_{D} = 3.6 A, V_{DS} = 360 V, see fig. 6 and 13 ^b		-	10	nC
Gate-Drain Charge	Q _{gd}				-	42	
Turn-On Delay Time	t _{d(on)}		•		14	-	- ns
Rise Time	t _r	V_{DD} = 450 V, I_D = 3.6 A, R_g = 12 Ω , R_D = 120 Ω , see fig. 10 ^b		-	25	-	
Turn-Off Delay Time	t _{d(off)}			-	90	-	
Fall Time	t _f			-	30	-	
Internal Drain Inductance	L_D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	-11
Internal Source Inductance	L _S			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s			•			
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the		-	3.6	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	14	
Body Diode Voltage	V_{SD}	$T_J = 25 ^{\circ}\text{C}, \ I_S = 3.6 \text{A}, \ V_{GS} = 0 \text{V}^{\text{b}}$		-	-	1.8	V
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 3.6 A, dI/dt = 100 A/μs ^b		-	430	650	ns
Body Diode Reverse Recovery Charge	Q _{rr}			-	1.4	2.1	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L _S and L				L _D)	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width \leq 300 μ s; duty cycle \leq 2 %.



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

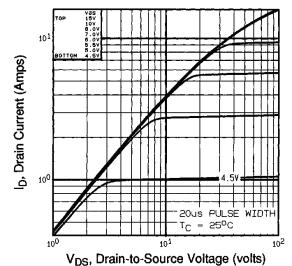


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

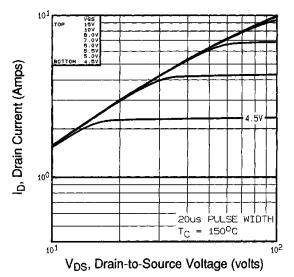


Fig. 2 -Typical Output Characteristics, $T_C = 150 \, ^{\circ}C$

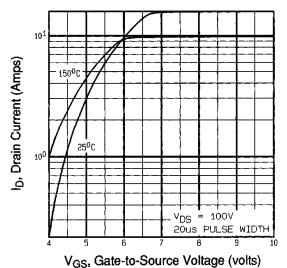


Fig. 3 - Typical Transfer Characteristics

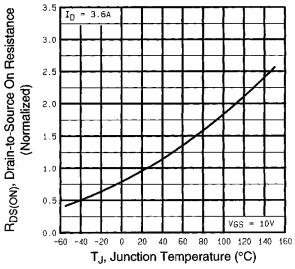


Fig. 4 - Normalized On-Resistance vs. Temperature



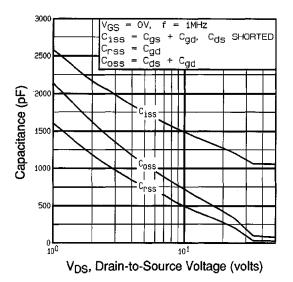


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

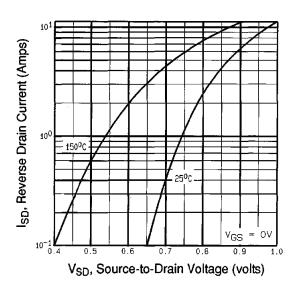


Fig. 7 - Typical Source-Drain Diode Forward Voltage

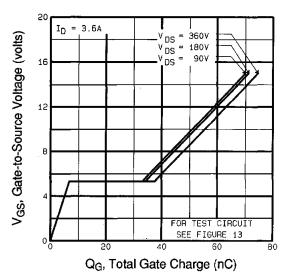


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

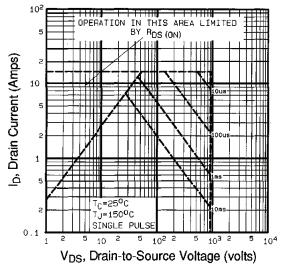


Fig. 8 - Maximum Safe Operating Area





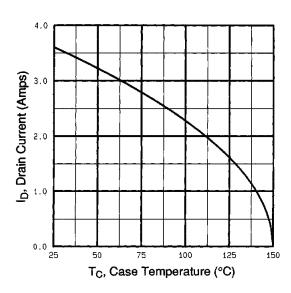


Fig. 9 - Maximum Drain Current vs. Case Temperature

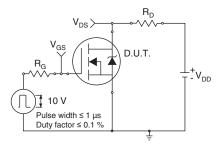


Fig. 10a - Switching Time Test Circuit

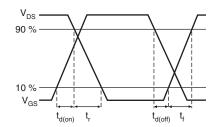


Fig. 10b - Switching Time Waveforms

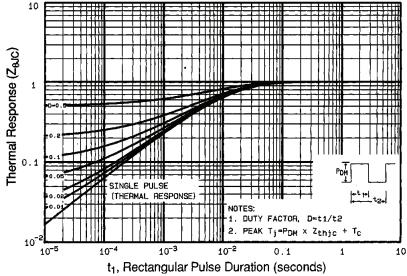


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

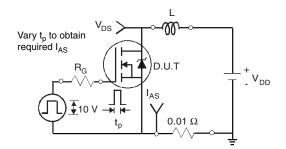


Fig. 12a - Unclamped Inductive Test Circuit

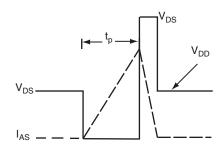


Fig. 12b - Unclamped Inductive Waveforms



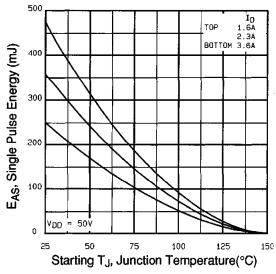


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

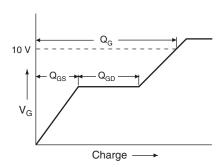


Fig. 13a - Basic Gate Charge Waveform

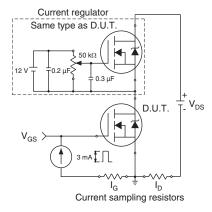
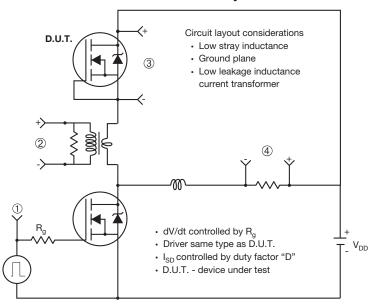


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



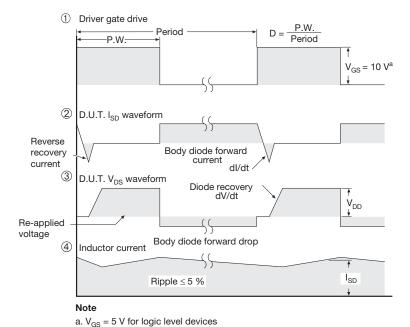


Fig. 14 - For N-Channel

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